



ICED 13

THE 19TH INTERNATIONAL CONFERENCE
ON ENGINEERING DESIGN

19th-22nd August 2013
Sungkyunkwan University (SKKU)
Seoul, Korea

Organised By

Creative Design Institute, Sungkyunkwan University
and the Design Society

Proceedings Volume DS75-04

DESIGN FOR HARMONIES

VOLUME 4: PRODUCT, SERVICE AND SYSTEMS DESIGN

Edited By

Udo Lindemann
Srinivasan V
Yong Se Kim
Sang Won Lee
Olivier de Weck
Yoo Suk Hong

Published by the Design Society

First published in 2013

This publication is copyright under the Berne Convention and the International Copyright Convention. All rights reserved. Apart from any fair dealing for the purpose of private study, research, criticism or review, as permitted under the Copyright, Designs and Patents Act of 1988, no part of this publication may be reproduced, stored in a retrieval system, or transmitted in any form or by any means, electronic, electrical, chemical, mechanical, photocopying, recording or otherwise, without the prior permission of the copyright owners. Unlicensed multiple copying of the contents of this publication is illegal. Inquiries should be addressed to the Design Society.

© 2013 The Design Society, unless otherwise stated.

The Design Society is a charitable body, registered in Scotland,
number SC 031694

ISBN 978-1-904670-47-6, EAN 9781904670476, 486 pages.

Printed by Lightning Source, Inc., La Vergne, TN, USA
and by Lightning Source UK Ltd., Milton Keynes, UK

The publishers are not responsible for any statement made in this publication. Data, discussion, and conclusions developed by authors are for information only and are not intended for use without independent substantiating investigation on the part of potential users. Opinions expressed are those of the Author and not necessarily those of the Design Society.

Preface by the Programme Chair

We welcome you to the proceedings of arguably the biggest conference on engineering design: 19th International Conference on Engineering Design (ICED13) held in Sungkyunkwan University, Seoul, Korea!

This proceedings is a compilation of the 342 peer-reviewed and accepted papers submitted to ICED13. The proceedings is published in different forms: a book of abstracts, a soft-copy of proceedings on a USB-based memory device and a hard-copy of proceedings, which is available via a print-on-demand supplier. All these different forms of proceedings are numbered against both Design Society and ISSN referencing to allow wider access, better referencing and improved citation in the near and distant future. All the accepted papers are divided among the following 9 themes: Design Processes; Design Theory and Research Methodology; Design Organisation and Management; Products, Services and Systems Design; Design for X, Design to X; Design Information and Knowledge; Human Behaviour in Design; Design Education; and Design Methods and Tools. The hard-copy of the proceedings is in turn divided into 9 volumes where each volume comprises papers from a theme. All the accepted papers are presented in podium or discussion sessions in the conference. It is important to make it explicit that all the accepted papers have successfully cleared the criteria for acceptance in ICED13. The division into podium and discussion sessions is solely based on grouping similar papers so as to allow relevant, connected, lively and stimulating presentations and discussions. For this year's conference we have introduced a number of novel schemes to reduce the bureaucratic load for authors and organisers and, it is hoped, to increase the quality of the conference. To name a few: (i) automatic production of the cover page of papers based on title of paper, details of authors, abstract and list of keywords in the Conference Management System, (ii) electronic acceptance of terms and conditions in copyrights, (iii) feedback of acceptance and quality of reviews to reviewers from authors, etc.

This proceedings is a consequence of dedicated efforts of many people, namely, the authors, the reviewers, the chairs and associate chairs of the various themes, and the members of the Programme Committee. The Programme Chair on behalf of Programme Committee would like to acknowledge the contributions of: (a) Authors for submitting papers, (b) Reviewers for providing timely comments and feedbacks to improve the quality of papers, (c) Chairs and Associate Chairs of themes for assisting in selection of reviewers, providing directions for improvements to papers with the status of major revisions, and helping in the final decisions of papers.

We hope that you enjoy the programme of ICED13 as much as we have enjoyed creating and organising it.



A handwritten signature in black ink, appearing to read 'Udo Lindemann'.

Udo Lindemann
Programme Chair



A handwritten signature in black ink, appearing to read 'Srinivasan V'.

Srinivasan V
Assistant Programme Chair

Preface by ICED13 Conference Chair

Welcome to the 19th International Conference on Engineering Design 2013 (ICED13), and its conference proceedings. The theme of ICED13, *Design for Harmonies*, is well reflected in the programme and papers of the conference. As design practice and research make progress, integration and incorporation of diverse viewpoints take more essential roles. ICED13 will make its mark in the history of ICED and the Design Society as an important cornerstone for harmonies in design.

Increasing numbers of presentations in topics like human behavior in design and product, service and systems design indicate that issues of harmonies of products and services and those of human-centered views and technology support are at the core of design research. With continued excellence in the topics of design methods and tools, design information and knowledge and design processes, strong research foundations of design have been confirmed in the programme. Presentations in design organisation and management, design for X, design to X, and design theory and research methodology also demonstrate the leadership of the Design Society community in these important issues. Design education is yet another important area where new needs and requirements appear as the roles of design become broader. As Seoul is the very first Asian city hosting ICED, more papers from Asian countries appear in ICED13. This reflects harmonies of East and West being strengthened in design research. ICED13 will make a good transition for drawing more such harmonies.

In addition to a technical programme of keynote, podium and discussion sessions, ICED13 has organized a few special events such as the Young Members Event. Ten selected presentations by young designers and design researchers will address the Future of Design. This event is open to the (young) public so that diverse harmonies can be achieved by the attendees. With opening and closing ceremonies and receptions as well as a conference banquet, diverse opportunities for cultural harmonies are prepared. For example, Korean traditional culture experiences are available for conference attendees and accompanying guests together with old Korean traditional buildings in order to draw harmonies from the Old and the New. The optional Gangnam-Style tour will introduce modern Korean culture as featured in the world hit music video.

We hope you enjoy ICED 13 and have the fun and excitement of Design for Harmonies.



A stylized, handwritten signature in black ink, appearing to read 'Yong Se Kim'.

Yong Se Kim
Conference Chair



A stylized, handwritten signature in black ink, appearing to read 'Sang Won Lee'.

Sang Won Lee
Assistant Conference Chair

Preface by the Design Society President

The 2013 International Conference on Engineering Design (ICED) will be the nineteenth held since the conference series was inaugurated in 1981. It will also be the sixth held under the auspices of the Design Society, an international society founded in 2001 to develop an understanding of all aspects of design. The previous five conferences have been in Stockholm, Melbourne, Paris, Stanford (California) and Copenhagen, and by holding the conference in Asia for the first time it is surely established as a truly world-wide event. The 2013 conference continues the tradition of holding the conference in an exciting location with a vibrant design research community and for which design is important to local industry and commerce. Seoul is exceptional in this regard, the dynamic heart of the world's second largest metropolis whose success is built on great design and engineering.

ICED13 also continues the format, established in 2009 and continued in 2011, of a conference programme made up of plenary sessions, podium presentations, discussion sessions with focused debate and workshops led by the Design Society's Special Interest Groups. We hope that this varied programme, combined with extensive opportunities for networking, will provide an exciting opportunity for researchers and practitioners to learn about the latest developments in design research and practice.

Organising an international conference takes an enormous amount of work, and I would like to express the thanks of the Society to the great team that has worked over many months to make the Conference a success. Especially I would like to thank Yong Se Kim, Sang Won Lee and colleagues at Sungkyunkwan University for their great work in the Organising Committee, and Udo Lindemann, Srinivasan V and the Programme Committee for bringing together such an excellent programme. Of course, their work would be in vain without the fantastic contributions of the authors, reviewers, theme chairs and session chairs, and the thanks of the Society are due to all of them.



A handwritten signature in black ink, which appears to read "Chris McMahon".

Chris McMahon
Design Society President

ICED13 Programme Committee

Udo Lindemann – Programme Chair, Technical University of Munich, Germany

Srinivasan V – Assistant Programme Chair, Technical University of Munich, Germany

Panos Papalambros – Design Society Representative, University of Michigan, USA

Chris McMahon – Design Society Representative, University of Bristol, UK

Yong Se Kim – Organising Committee Representative, Sungkyunkwan University, Korea

Sang Won Lee – Organising Committee Representative, Sungkyunkwan University, Korea

ICED13 Organising Committee

Yong Se Kim – Conference Chair, Sungkyunkwan University, Korea

Sang Won Lee – Assistant Conference Chair, Sungkyunkwan University, Korea

Tom Howard – Technical University of Denmark, Denmark

Chris McMahon – University of Bristol, UK

Yoo Suk Hong – Seoul National University, Korea

Haeseong Jee – Hongik University, Korea

Jong Won Kim – Seoul National University, Korea

Kee-Ok Kim – Sungkyunkwan University, Korea

Myoun Kim – Sungkyunkwan University, Korea

Ji Hyun Lee – KAIST, Korea

Seong Il Lee – Sungkyunkwan University, Korea

ICED13 Theme Chairs

Design Processes

John Clarkson, University of Cambridge, UK
Gaetano Cascini, Politecnico di Milano, Italy

Design Theory and Research Methodology

Amaresh Chakrabarti, Indian Institute of Science, India
Yoram Reich, Tel Aviv University, Israel

Design Organisation and Management

Marco Cantamessa, Politecnico di Torino, Italy
Bernard Yannou, Ecole Centrale Paris, France

Products, Services and Systems Design

Olivier de Weck, Massachusetts Institute of Technology, USA
Yoo Suk Hong, Seoul National University, Korea

Design for X, Design to X

Tim McAlloone, Technical University of Denmark, Denmark
Sandro Wartzack, Friedrich-Alexander-University Erlangen-Nuremberg, Germany

Design Information and Knowledge

Andy Dong, The University of Sydney, Australia
Ying Liu, National University of Singapore, Singapore

Human Behaviour in Design

Petra Badke-Schaub, Delft University of Technology, The Netherlands
Keiichi Sato, Illinois Institute of Technology, USA

Design Education

Bill Ion, University of Strathclyde, UK
Johan Malmqvist, Chalmers University of Technology, Sweden

Design Methods and Tools

Panos Papalambros, University of Michigan, USA
Wei Chen, Northwestern University, USA

ICED13 Scientific Committee

- Achiche, Sofiane** - Polytechnique Montreal, Canada
- Adams, Robin** - Purdue University, USA
- Agogino, Alice Merner** - University of California at Berkeley, USA
- Agogue, Marine** - ENSMP, France
- Ahmed-Kristensen, Saeema** - Technical University of Denmark, Denmark
- Ahn, Jaemyung** - KAIST, Korea
- Albers, Albert** - Karlsruhe Institute of Technology, Germany
- Allen, Janet Katherine** - University of Oklahoma, USA
- Allison, James T.** - University of Illinois at Urbana-Champaign, USA
- Almfelt, Lars** - Chalmers University of Technology, Sweden
- Anderl, Reiner** - TU Darmstadt, Germany
- Andersson, Kjell** - KTH Royal Institute of Technology, Sweden
- Andrade, Ronaldo** - Universidade Federal do Rio de Janeiro, Brazil
- Annamalai Vasantha, Gokula Vijaykumar** - University of Strathclyde, UK
- Aoussat, Améziane** - ENSAM, France
- Arai, Eiji** - Osaka University, Japan
- Auricchio, Marco** - Imperial College London, UK
- Badke-Schaub, Petra** - Delft University of Technology, Netherlands
- Balan, Gurumoorthy** - Indian Institute of Science, India
- Ben-Ahmed, Walid** - RENAULT, France
- Bertoni, Marco** - Luleå University of Technology, Sweden
- Bey, Niki** - Technical University of Denmark, Denmark
- Bhamra, Tracy** - Loughborough University, UK
- Bigand, Michel** - Ecole Centrale de Lille, France
- Binz, Hansgeorg** - University of Stuttgart, Germany
- Birkhofer, Herbert** - TU Darmstadt, Germany
- Björnemo, Robert** - Lund University, Sweden
- Björk, Evastina, Lilian** - NHV Nordic School of Public Health, Sweden
- Blanco, Eric** - Grenoble Institute of Technology, France
- Blessing, Lucienne** - University of Luxembourg, Luxembourg
- Boelskifte, Per** - Technical University of Denmark, Denmark
- Bohemia, Erik** - Loughborough University, UK
- Bojetic, Nenad** - University of Zagreb, Croatia
- Boks, Casper** - Norwegian University of Science and Technology, Norway
- Bolognini, Francesca** - Nukem Technologies, Italy
- Booker, Julian David** - University of Bristol, UK
- Bordegoni, Monica** - Politecnico di Milano, Italy
- Borg, Jonathan C.** - University of Malta, Malta
- Boujut, Jean-François** - Grenoble Institute of Technology, France
- Bouwhuis, Dominic G** - TU Eindhoven, Netherlands
- Bracewell, Robert Henry** - University of Cambridge, UK
- Brown, David C.** - Worcester Polytechnic Institute, USA
- Bruun, Hans Peter Lomholt** - Technical University of Denmark, Denmark
- Burchardt, Carsten** - Siemens Industry Software GmbH & Co. KG, Germany
- Burvill, Colin Reginald** - University of Melbourne, Australia
- Bylund, Nicklas** - Sandvik Coromant, Sweden
- Cagan, Jonathan** - Carnegie Mellon University, USA
- Caillaud, Emmanuel** - ENSAM, France
- Campbell, Matthew Ira** - University of Texas at Austin, USA
- Cantamessa, Marco** - Politecnico di Torino, Italy
- Casakin, Herman** - Ariel University, Israel
- Cascini, Gaetano** - Politecnico di Milano, Italy
- Cash, Philip** - Technical University of Denmark, Denmark
- Chakrabarti, Amaresh** - Indian Institute of Science, India
- Chan, Kuei-Yuan** - National Cheng Kung University, Taiwan

ICED13 Scientific Committee cont.

- Chen, Wei - Northwestern University, USA
Childs, Peter R.N. - Imperial College London, UK
Choi, Young Mi - Georgia Institute of Technology, USA
Chu, Chih-Hsing - National Tsing Hua University, Taiwan
Chun-Hsien, Chen - Nanyang Technological University, Singapore
Clarkson, Peter John - University of Cambridge, UK
Claudio, Dell'Era - Politecnico di Milano, Italy
Coatanéa, Eric - Aalto University, Finland
Cormican, Kathryn - National University of Ireland, Ireland
Coutellier, Daniel - University of Valenciennes, France
Crilly, Nathan - University of Cambridge, UK
Cugini, Umberto - Politecnico di Milano, Italy
Culley, Steve - University of Bath, UK
Daly, Shanna - University of Michigan, USA
Deans, Joe - University of Auckland, New Zealand
Dekoninck, Elies Ann - University of Bath, UK
Dong, Andy - University of Sydney, Australia
Donndelinger, Joseph A. - General Motors LLC, USA
Dorst, Kees - University of Technology Sydney, Australia
Duffy, Alex - University of Strathclyde, UK
Eckert, Claudia - Open University, UK
Eigner, Martin - TU Kaiserslautern, Germany
Ekman, Kalevi - Aalto University, Finland
Ellman, Asko Uolevi - Tampere University of Technology, Finland
Elspass, Wilfried J. - Zurich University of Applied Sciences, Switzerland
Eppinger, Steven - Massachusetts Institute of Technology, USA
Ericson, Åsa - Luleå University of Technology, Sweden
Eris, Özgür - Delft University of Technology, Netherlands
Evans, Steve - University of Cambridge, UK
Fadel, Georges M. - Clemson University, USA
Fan, Ip-Shing - Cranfield University, UK
Fantoni, Gualtiero - University of Pisa, Italy
Fargnoli, Mario - Sapienza University of Rome, Italy
Feldhusen, Jörg - RWTH Aachen, Germany
Filippi, Stefano - University of Udine, Italy
Finger, Susan - Carnegie Mellon University, USA
Fischer, Xavier - ESTIA, France
Frankenberger, Eckart - Airbus, Germany
Frise, Peter R. - University of Windsor, Canada
Fujita, Kikuo - Osaka University, Japan
Fukuda, Shuichi - Stanford University, USA
Gardoni, Mickael - ÉTS / INSA de Strasbourg, Canada
Georgiev, Georgi - Kobe University, Japan
Gerhard, Detlef - Vienna University of Technology, Austria
Gericke, Kilian - University of Luxembourg, Luxembourg
Gero, John - Krasnow Institute for Advanced Study, USA
Gerson, Philips M. - Hanze University of Applied Sciences, Netherlands
Giess, Matt - Glue Reply, UK
Goel, Ashok - Georgia Institute of Technology, USA
Goh, Yee Mey - Loughborough University, UK
Göhlich, Dietmar - TU Berlin, Germany
Goker, Mehmet H. - Salesforce.com, USA
Goldschmidt, Gabriela - Technion - Israel Institute of Technology, Israel
Gomes, Samuel - University of Technology Belfort-Montbéliard, France
Graessler, Iris - Robert Bosch GmbH, Germany
Graziosi, Serena - Politecnico di Milano, Italy
Green, Graham - University of Glasgow, UK
Gries, Bruno - Capgemini Consulting, Germany
Grimheden, Martin - KTH Royal Institute of Technology, Sweden
Grote, Karl-Heinrich - Otto-von-Guericke University Magdeburg, Germany
Gzara, Lilia - Grenoble Institute of Technology, France

Hales, Crispin - Hales & Gooch Ltd., USA
Hansen, Claus Thorp - Technical University of Denmark, Denmark
Hatchuel, Armand - Mines ParisTech, France
Helten, Katharina - Technical University of Munich, Germany
Henderson, Mark Richard - Arizona State University, USA
Hicks, Ben - University of Bath, UK
Hoffenson, Steven - Chalmers University of Technology, Sweden
Hohne, Gunter - TU Ilmenau, Germany
Holliger, Christoph - University of Applied Sciences Northwestern Switzerland, Switzerland
Holmlid, Stefan - Linköping University, Sweden
Hölttä-Otto, Katja - Singapore University of Design and Technology, Singapore
Hong, Yoo Suk - Seoul National University, Korea
Horvath, Imre - Delft University of Technology, Netherlands
Hosnedl, Stanislav - University of West Bohemia, Czech Republic
Howard, Thomas J. - Technical University of Denmark, Denmark
Huet, Greg - École de Technologie Supérieure, Canada
Ijmah, Winifred - University of Strathclyde, UK
Ilies, Horea - University of Connecticut, USA
Ion, William - University of Strathclyde, UK
Isaksson, Karl Ola - GKN Aerospace Engine Systems, Sweden
Jackson, Mats - Mälardalen University, Sweden
Jagtap, Santosh - Lund University, Sweden
Johannesson, Hans - Chalmers University of Technology, Sweden
Johansson, Glenn - Jönköping University, Sweden
Johnson, Aylmer - University of Cambridge, UK
Jun, Thomas - Loughborough University, UK
Jupp, Julie Rose - University of Technology Sydney, Australia
Kannengiesser, Udo - Metasonic AG, Germany
Karlsson, Lennart - Luleå University of Technology, Sweden
Kazakci, Akin Osman - Mines ParisTech, France
Keates, Simeon - University of Abertay Dundee, UK
Keldmann, Troels - Keldmann Healthcare A/S, Denmark
Kelly, Jarod - University of Michigan, USA
Kim, Harrison - University of Illinois at Urbana-Champaign, USA
Kim, Kee-Ok - Sungkyunkwan University, Korea
Kim, Sun K - Stanford University, USA
Kim, Yong Se - Sungkyunkwan University, Korea
Kiryama, Takashi - Tokyo University of the Arts, Japan
Kitamura, Yoshinobu - Osaka University, Japan
Kloberdanz, Hermann - TU Darmstadt, Germany
Kokkolaras, Michael - McGill University, Canada
Kota, Srinivas - Grenoble Institute of Technology, France
Kovacevic, Ahmed - City University London, UK
Krause, Dieter - Hamburg University of Technology, Germany
Kreimeyer, Matthias - MAN Truck & Bus AG, Germany
Kremer, Gul - Penn State University, USA
Kristensen, Tore - Copenhagen Business School, Denmark
Kuosmanen, Petri - Aalto University, Finland
Larsson, Andreas - Lund University, Sweden
Larsson, Tobias C. - Blekinge Institute of Technology, Sweden
Le Masson, Pascal - Mines ParisTech, France
Leary, Martin John - RMIT university, Australia
Lee, Sang Won - Sungkyunkwan University, Korea
Legardeur, Jeremy - ESTIA, France
Lenau, Torben Anker - Technical University of Denmark, Denmark
Levy, Pierre Denis - TU Eindhoven, Netherlands
Liem, André - Norwegian University of Science and Technology, Norway
Lilly, Blaine - Ohio State University, USA
Lindahl, Mattias - Linköping University, Sweden
Lindemann, Udo - Technical University of Munich, Germany
Linsey, Julie - Georgia Institute of Technology, USA
Liu, Ying - Cardiff University, UK

ICED13 Scientific Committee cont.

- Lloveras, Joaquim - TU Catalonia, Spain
Mabogunje, Ade - Stanford University, USA
MacDonald, Erin - Iowa State University, USA
MacGregor, Steven Patrick - IESE Business School, Spain
Maier, Anja Martina - Technical University of Denmark, Denmark
Malak, Richard - Texas A&M, USA
Malmqvist, Johan Lars - Chalmers University of Technology, Sweden
Manfredi, Enrico - University of Pisa, Italy
Marini, Vinicius Kaster - Technical University of Denmark, Denmark
Marjanovic, Dorian - University of Zagreb, Croatia
Marle, Franck - Ecole Centrale Paris, France
Matta, Nada - Universite of Technology of Troyes, France
Matthews, Jason Anthony - University of Glamorgan, UK
Matthiesen, Sven - Karlsruhe Institute of Technology, Germany
Maurer, Maik - Technical University of Munich, Germany
McAloone, Tim C. - Technical University of Denmark, Denmark
McDonnell, Janet Theresa - Central Saint Martins, UK
McKay, Alison - University of Leeds, UK
McMahon, Chris - University of Bristol, UK
Meboldt, Mirko - ETH Zurich, Switzerland
Mekhilef, Mounib - University of Orleans, France
Merlo, Christophe - ESTIA, France
Millet, Dominique - SUPMECA Toulon, France
Mocko, Gregory Michael - Clemson University, USA
Moehringer, Stefan - Simon Moehringer Anlagenbau GmbH, Germany
Moes, Niels - Delft University of Technology, Netherlands
Montagna, Francesca - Politecnico di Torino, Italy
Mortensen, Niels Henrik - Technical University of Denmark, Denmark
Mörtl, Markus - Technical University of Munich, Germany
Moshaiov, Amiram - Tel Aviv University, Israel
Mougenot, Céline - Tokyo Institute of Technology, Japan
Moultre, James - University of Cambridge, UK
Mourelatos, Zissimos P. - Oakland University, USA
Mulet, Elena - University of Jaume, Spain
Mullineux, Glen - University of Bath, UK
Murakami, Tamotsu - University of Tokyo, Japan
Nadeau, Jean-Pierre - ENSAM, France
Nagai, Yukari - JAIST, Japan
Nagel, Jacquelyn - James Madison University, USA
Newnes, Linda - University of Bath, UK
Nomaguchi, Yutaka - Osaka University, Japan
Norell Bergendahl, Margareta E B - KTH Royal Institute of Technology, Sweden
Oehmen, Josef - Massachusetts Institute of Technology, USA
Öhrwall Rönnbäck, Anna B - Linköping University, Sweden
Olesen, Jesper - Bang & Olufsen, Denmark
Ölundh Sandström, Gunilla - KTH Royal Institute of Technology, Sweden
Ölvander, Johan - Linköping University, Sweden
Otto, Kevin - Singapore University of Design and Technology, Singapore
Ottosson, Stig - Gjøvik University College, Norway
Ouertani, Mohamed Zied - ABB, Germany
Ovtcharova, Jivka - Karlsruhe Institute of Technology, Germany
Paetzold, Kristin - University Bundeswehr Munich, Germany
Palm, William John - Roger Williams University, USA
Papalambros, Panos Y. - University of Michigan, USA
Parkinson, Matt - Pennsylvania State University, USA
Pavkovic, Neven - University of Zagreb, Croatia
Peters, Diane - LMS International, USA

Petiot, Jean-François - Ecole Centrale de Nantes, France
Ploug, Ole - Hydro Aluminium, Denmark
Prasad, Brian - Parker Aerospace, USA
Rai, Rahul - SUNY Buffalo, USA
Raine, John Kenneth - Auckland University of Technology, New Zealand
Reich, Yoram - Tel Aviv University, Israel
Reidsema, Carl Allen - University of Queensland, Australia
Remmen, Arne - Aalborg University, Denmark
Ren, Yi - University of Michigan, USA
Rexfelt, Oskar - Chalmers University of Technology, Sweden
Riel, Andreas Erik - Grenoble Institute of Technology, France
Riitahuhta, Asko Olavi - Tampere University of Technology, Finland
Rinderle, James - University of Massachusetts, USA
Ritzén, Sofia - KTH Royal Institute of Technology, Sweden
Rizzi, Caterina - University of Bergamo, Italy
Rohmer, Serge - University of Technologie of Troyes, France
Rosen, David - Georgia Institute of Technology, USA
Rotini, Federico - University of Firenze, Italy
Roucoules, Lionel - ENSAM, France
Rovida, Edoardo - Politecnico di Milano, Italy
Russo, Davide - University of Bergamo, Italy
Sachse, Pierre - University of Innsbruck, Austria
Sagot, Jean-Claude - University of Technology Belfort Montbeliard, France
Sakao, Tomohiko - Linköping University, Sweden
Salehi, Vahid - BMW AG, Germany
Salustri, Filippo Arnaldo - Ryerson University, Canada
Sangiorgi, Daniela - Lancaster University, UK
Sarkar, Prabir - Indian Institute of Technology Ropar, India
Sarkar, Somwrita - University of Sydney, Australia
Sato, Keiichi - Illinois Institute of Technology, USA
Schabacker, Michael - Otto-von-Guericke University Magdeburg, Germany
Schaefer, Dirk - Georgia Institute of Technology, USA
Schaub, Harald - IABG, Germany
Seepersad, Carolyn Conner - University of Texas at Austin, USA
Seering, Warren - Massachusetts Institute of Technology, USA
Sen, Chiradeep - Oregon State University, USA
Setchi, Rossi - Cardiff University, UK
Shea, Kristina - ETH Zurich, Switzerland
Shimomura, Yoshiki - Tokyo Metropolitan University, Japan
Siadat, Ali - ENSAM, France
Sigurjónsson, Jóhannes B. - Norwegian University of Science and Technology, Norway
Simpson, Timothy W. - Penn State University, USA
Singh, Vishal - Aalto University, Finland
Snider, Chris - University of Bath, UK
Söderberg, Rikard - Chalmers University of Technology, Sweden
Sonalkar, Neeraj - Stanford University, USA
Spitas, Christos - Delft University of Technology, Netherlands
Stal-Le Cardinal, Julie - Ecole Centrale Paris, France
Stankovic, Tino - ETH Zurich, Switzerland
Stark, Rainer G. - Berlin Institute of Technology, Germany
Stelzer, Ralph - TU Dresden, Germany
Stetter, Ralf - University of Applied Sciences Ravensburg-Weingarten, Germany
Stören, Sigurd - Norwegian University of Science and Technology, Norway
Storga, Mario - University of Zagreb, Croatia
Subrahmanian, Eswaran - Carnegie Mellon University, USA
Suh, Eun Suk - Seoul National University, Korea
Summers, Joshua David - Clemson University, USA
Sundin, Erik - Linköping University, Sweden
Tan, Adrian Ronald - BIO Intelligence Service, France
Tan, James Ah-Kat - Ngee Ann Polytechnic, Singapore
Taura, Toshiharu - Kobe University, Japan

ICED13 Scientific Committee cont.

- Tegel, Oliver** - Porsche AG, Germany
- Terpenny, Janis P.** - Iowa State University, USA
- Thallemer, Axel** - Universität für Künstlerische und Industrielle Gestaltung, Austria
- Thoben, Klaus-Dieter** - University of Bremen, Germany
- Tollenaere, Michel** - Grenoble Institute of Technology, France
- Tomiyama, Tetsuo** - Cranfield University, UK
- Törlind, Peter** - Luleå University of Technology, Sweden
- Torry-Smith, Jonas Mørkeberg** - Technical University of Denmark, Denmark
- Troussier, Nadege** - University of Technology of Troyes, France
- Udiljak, Toma** - University of Zagreb, Croatia
- Vajna, Sandor J.** - Otto-von-Guericke University Magdeburg, Germany
- Valderrama Pineda, Andres Felipe** - Aalborg University, Denmark
- Vance, Judy M.** - Iowa State University, USA
- Vaneker, Tom Henricus Jozef** - University of Twente, Netherlands
- Vargas Hernandez, Noe** - University of Texas at El Paso, USA
- V, Srinivasan** - Technical University of Munich, Germany
- Vermaas, Pieter** - Delft University of Technology, Netherlands
- Vietor, Thomas** - Braunschweig University of Technology, Germany
- Vukic, Fedja** - University of Zagreb, Croatia
- Wang, Charlie C.L.** - Chinese University of Hong Kong, Hong Kong
- Wang, Yue** - Hong Kong University of Science and Technology, Hong Kong
- Wartzack, Sandro** - Friedrich-Alexander-Universität Erlangen-Nürnberg, Germany
- Weber, Christian** - TU Ilmenau, Germany
- Weil, Benoit** - Mines ParisTech, France
- Weiss, Menachem P.** - Technion - Israel Institute of Technology, Israel
- Whitfield, Ian** - University of Strathclyde, UK
- Whitney, Daniel E** - Massachusetts Institute of Technology, USA
- Wood, Kristin** - Singapore University of Design and Technology, Singapore
- Wörösch, Michael** - Technical University of Denmark, Denmark
- Wynn, David** - Cambridge University, UK
- Yan, Liang** - National University of Singapore, Singapore
- Yan, Xiu-Tian** - University of Strathclyde, UK
- Yanagisawa, Hideyoshi** - University of Tokyo, Japan
- Yang, Maria** - Massachusetts Institute of Technology, USA
- Yannou, Bernard** - Ecole Centrale Paris, France
- Yilmaz, Seda** - Iowa State University, USA
- Yuen, Matthew** - Hong Kong University of Science and Technology, Hong Kong
- Zavbi, Roman** - University of Ljubljana, Slovenia
- Zeiler, Wim** - TU Eindhoven, Netherlands
- Zeng, Yong** - Concordia University, Canada

Table of Contents

Preface by ICED13 Programme Chair
Preface by ICED13 Conference Chair
Preface by the Design Society President
ICED13 Programme Committee
ICED13 Organising Committee
ICED13 Theme Chairs
ICED13 Scientific Committee

VOLUME 4: PRODUCTS, SERVICES AND SYSTEMS DESIGN

Complexity management in plant engineering <i>Maik Maurer, Christian Wölfling</i>	4-1
System architecture change decisions in multi-variant product portfolios <i>Maximilian Kissel, Udo Lindemann</i>	4-11
Complexity and preference based methodology for product line planning of customizable products <i>Sebastian Schubert, Jan Erik Heller, Johannes van der Beek, Jörg Feldhusen</i>	4-21
An assessment of methodical approaches to support the development of modular product families <i>Dieter Krause, Sebastian Ripperda</i>	4-31
Similarity-based concept development for modular platform systems <i>Nadia Anggraeni, Sebastian Maltzahn, Reiner Anderl</i>	4-41
Performance measurement framework for multi-role aircraft under performance based logistics <i>Chang Ha Lee, Gwang Ki Min, Mayooraan Kiritharan, Yoo S. Hong</i>	4-51
Decision support for regional telehealth integration: A system dynamic approach <i>Camille Jean, Marija Jankovic, Julie Le Cardinal, Jean-Claude Bocquet</i>	4-61
Inquiry into Service Processes from the Perspective of 'Steps' <i>Ryoichi Tamura, Akihiro Honda</i>	4-71
Design of a healthcare service: Tele dermatology <i>Tu Anh Duong, Julie Le Cardinal, Jean-Claude Bocquet</i>	4-79
Service design for social space in smart city in case of a Taipei MRT station exit <i>Sheng-Ming Wang, Daniel Aguilera, Frida Cobar, John Aganda</i>	4-89
Remodel the public service based on behavioral maps and service design in case of Taipei MRT exit <i>Sheng-Ming Wang, Rhecel Molina, Meutia Anizar, Wojciech Wilczek</i>	4-99

A comparison of three types of services with self-service technologies in service encounters	4-109
<i>Shu-Shiuan Ho, Yi-Chia Lee, Tung-Jung Sung</i>	
Obstacles and development of support for translation of configuration rules	4-119
<i>Anna Tidstam, Johan Malmqvist</i>	
Redesign of product service system applying failure mode and effects analysis and importance performance analysis	4-129
<i>Chih-Chuan Chen, Ming-Chuan Chiu</i>	
Service element level customization for product-service systems using context-eased activity modeling	4-139
<i>Yong Se Kim, Sang Won Lee, Jin Hui Kim</i>	
Architecting systems for optimal lifetime adaptability	4-149
<i>Avner Engel, Yoram Reich</i>	
Semiotic basis for designing product architecture	4-159
<i>Fei Hu, Keichii Sato, Xi Zhang, Taiping Zhu</i>	
Process visualisation of product family development methods	4-169
<i>Gregor Beckmann, Dieter Krause</i>	
Design for adaptability in multi-variant product families	4-179
<i>Markus Greisel, Maximilian Kissel, Benjamin Spinola, Matthias Kreimeyer</i>	
Structural complexity: Quantification, validation and its systemic implications for engineered complex systems	4-189
<i>Kaushik Sinha, Harun Omer, Olivier L. de Weck</i>	
Using PLM and trade-off curves to support set-based convergence of product platforms	4-199
<i>Christoffer Levandowski, Anders Forslund, Hans Johannesson</i>	
Towards the development of commonal product programs	4-209
<i>Sandra Eilmus, Sebastian Ripperda, Dieter Krause</i>	
Extending product modeling methods for integrated product development	4-219
<i>Martin Bonev, Michael Wörösch, Dagný Hauksdóttir, Lars Hvam</i>	
A case study on exploring energy user needs toward design for building energy saving	4-229
<i>Yeon Koo Hong, Kee-Ok Kim, Yong Se Kim, Pil-Ho Lee, Dae Hoon Kim, Sang Won Lee</i>	
Design principles for robot inclusive spaces	4-239
<i>Rajesh Elara Mohan, Nicolas Rojas, Sue Seah, Ricardo Sosa</i>	
Value of virtual prototyping – A strategic resource based view	4-249
<i>Simo-Pekka Sakari Leino, Tapio Koivisto, Asko Riitahuhta</i>	
Adding product value through additive manufacturing	4-259
<i>Robert Ian Campbell, Haeseong Jee, Yong Se Kim</i>	
Conceptual design of product service systems driven by performance	4-269
<i>Zai Fang Zhang</i>	

Model-based framework for management of PSS design knowledge <i>Yutaro Nemoto, Ken Kawase, Fumiya Akasaka, Yoshiki Shimomura</i>	4-279
A product-service system design framework using objective-oriented concepts and blueprint <i>Seung Ki Moon, Hyung Sool Oh, Samyeon Kim, Jesun Hwang</i>	4-287
A framework for enterprise-driven product service systems design <i>Namwooo Kang, Fred M. Feinberg, Panos Y. Papalambros</i>	4-297
Strategy, business models or tactics – What is product-service systems (PSS) literature talking about? <i>Wiebke Reim, Vinit Parida, Daniel Örtqvist</i>	4-309
Interplay between offering, provider and customer in product-service system design <i>Tuomas Ritola, Eric Coatanéa</i>	4-319
Developing business models for extended products in manufacturing service ecosystems <i>Klaus-Dieter Thoben, Stefan Wiesner, Sergio Gusmeroli, Jens Eschenbaecher</i>	4-329
Playful conceptual design of industrial product service systems: An Experiment <i>Daniel Meuris, Michael Herzog, Matthias Köster, Tim Sadek</i>	4-339
Design activity and team interaction characteristics: A case study of protocol analysis on team-based product-service systems design processes <i>Sang Won Lee, Jun Lee, Nanhyeon Jo, Yong Se Kim</i>	4-349
Interactive modeling and evaluation of product-service systems <i>Philipp Herzberger, Florian Georg Hans Behncke, Sebastian Schenkl, Udo Lindemann</i>	4-359
Industry specific PSS: A study of opportunities and barriers for maritime suppliers <i>Jakob Axel Bejbro Andersen, Tim C. McAloone, Adrià Garcia i Mateu</i>	4-369
PLM support for development of modular product families <i>Hans Peter Lomholt Bruun, Niels Henrik Mortensen, Ulf Harlou</i>	4-379
An analysis of decomposition approach applications in design engineering & suggestions for improvement <i>Junfeng Ma, Gul Kremer</i>	4-389
Geometric and topological modelling of 3d crumpled structures <i>Serge Rohmer, Alexis Merat, Vincent Floderer, Alain Copinet</i>	4-399
Determining module replacement timing of product for balancing quality and production cost <i>Jae Hun Jeong, Daeyoung Kim, Wooseok Jang, Jihwan Lee, Yoo S. Hong, Yongtae Park</i>	4-407
An approach for cycle-robust platform design <i>Wolfgang Bauer, Fatos Elezi, Maik Maurer</i>	4-417
Examination of modularization metrics in industry <i>Markus Heilemann, Steve J. Culley, Meike Schlüter, Hans-Joachim Haase</i>	4-427

Characterizing and comparing service innovation in manufacturing firms and service organizations <i>Oskar Rexfelt, Lars Almfelt, Johan Lars Malmqvist</i>	4-437
Enhancing supply chain collaboration in automotive industry by value driven simulation <i>Massimo Panarotto, Tobias C. Larsson, Andreas Larsson</i>	4-447
Jùjū, an enabling solution to guarantee digital inclusion in the perspective of the smart city <i>Diego Dalia</i>	4-457